TOSHIBA HIGH EFFICIENCY DIODE STACK (HED) SILICON EPITAXIAL TYPE

# 20DL2CZ51A,20FL2CZ51A

Switching Mode Power Supply Applications Converter & Chopper Applications

Repetitive Peak Reverse Voltage: VRRM = 200 V, 300 V

• Average Output Rectified Current: IO = 20 A

• Ultra Fast Reverse-Recovery Time:  $t_{rr} = 35 \text{ ns (Max)}$ 

• Low Switching Losses and Output Noise

## ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	20DL2CZ51A	V <sub>RRM</sub>	200	
	20FL2CZ51A	V KKM	300	V
Average Output Rectified Current		Io	20	A
Peak One Cycle Surge Forward Current (Sine Wave)		I <sub>FSM</sub>	100 (50 H <sub>Z</sub> ) 110 (60 H <sub>Z</sub> )	Α
Junction Temperature		Tj <	-40 to 150	/°C
Storage Temperature Range		T <sub>stg</sub>	-40 to 150	⟨ <b>°</b> ¢
	·		//	

Unit: mm

15.8 ± 0.5

03.6 ± 0.2

3.5

10-0.15

5.45 ± 0.2

13 2

10-0.15

13 2

10-0.15

13 2

10-0.15

1 ANODE
2 ANODE
3 CATHODE

JEDEC

JEITA

TOSHIBA

12-16E1A

Weight: 5.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high

temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

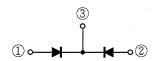
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

# ELECTRICAL CHARACTERISTICS (Ta = 25°C)

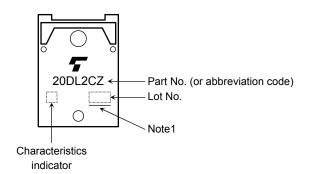
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Peak Forward 20DL2CZ51A	VEM	I <sub>EM</sub> = 10 A	1	_	0.98	V
Voltage 20FL2CZ51A	VFIVI	IFIM - 10 A	1	_	1.3	•
Repetitive Peak ReverseCurrent	IRRM	V <sub>RRM</sub> = Rated	ı	_	50	μΑ
Reverse Recovery Time	t <sub>rr</sub>	$I_F = 2 \text{ A, di / dt} = -50 \text{ A / } \mu\text{s}$	ı	_	35	ns
Forward Recovery Time t <sub>fr</sub>		I <sub>F</sub> = 1 A	ı	_	100	ns
Thermal Resistance	R <sub>th (j-c)</sub>	Total DC, Junction to Case	_	_	2.0	°C / W

V<sub>FM</sub>, I<sub>RRM</sub>, t<sub>rr</sub>, t<sub>fr</sub>: A value applied to one cell.

## **POLARITY**



### **MARKING**



Abbreviation Code	Part No.		
20DL2CZ	20DL2CZ51A		
20FL2CZ	20FL2CZ51A		

Note1: A line under a Lot No. identifies the indication of product Labels

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

## **Handling Precaution**

The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings. The following are the general derating methods that we recommend when you design a circuit with a device.

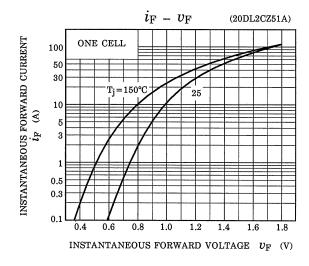
VRRM: We recommend that the worst case voltage, including surge voltage, be no greater than 80% of the absolute maximum rating of VRRM for a DC circuit and be no greater than 50% of that of VRRM for an AC circuit. VRRM has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.

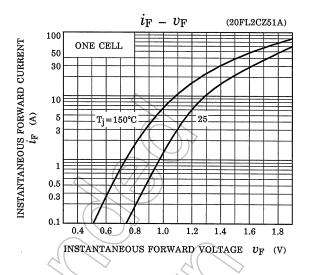
IO: We recommend that the worst case current be no greater than 80% of the absolute maximum rating of IO. Carry out adequate heat design. If you can't design a circuit with excellent heat radiation, set the margin by using an allowable Tc max-IO curve.

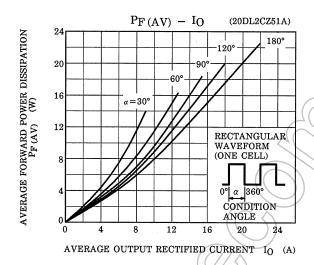
This rating specifies the non-repetitive peak current in one cycle of a 50-Hz sine wave, condition angle 180. Therefore, this is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.

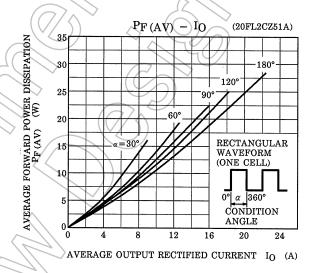
We recommend that a device be used at a Tj of below 120°C under the worst load and heat radiation conditions.

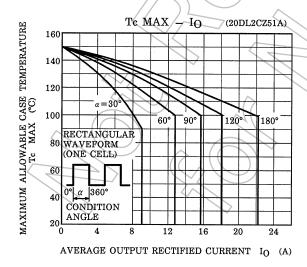
Please refer to the Rectifiers databook for further information.

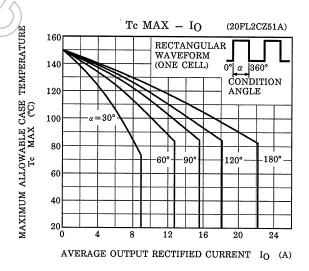


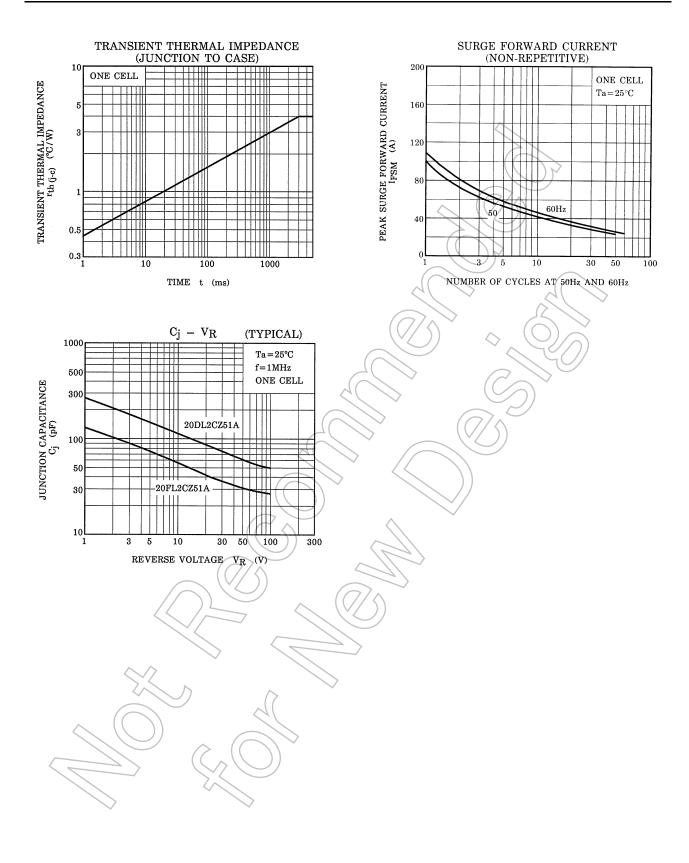












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